



# SPP8803B

## P-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPP8803B is the Dual P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

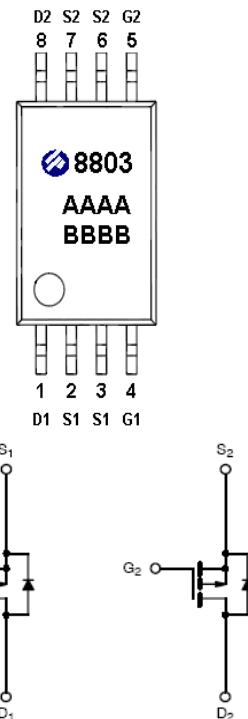
### FEATURES

- -20V/-7.0A,RDS(ON)= 22mΩ@VGS=-4.5V
- -20V/-6.0 A,RDS(ON)=28mΩ@VGS=-2.5V
- -20V/-5.0 A,RDS(ON)=40mΩ@VGS=-1.8V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TSSOP-8P package design

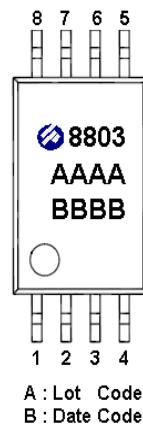
### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

### PIN CONFIGURATION(TSSOP – 8P)



### PART MARKING





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### PIN DESCRIPTION

Pin	Symbol	Description
1	D1	Drain
2	S1	Source
3	S1	Source
4	G1	Gate
5	G2	Gate
6	S2	Source
7	S2	Source
8	D2	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPP8803BTS8RGB	TSSOP- 8P	8803

※ SPP8803BTS8RGB : 13" Tape Reel ; Pb – Free; Halogen -Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-20	V
Gate –Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current(T <sub>J</sub> =150°C)	TA=25°C	ID	A
	TA=70°C		
Pulsed Drain Current	I <sub>DM</sub>	-30	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	-2.3	A
Power Dissipation	TA=25°C	P <sub>D</sub>	W
	TA=70°C		
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	80	°C/W



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### ELECTRICAL CHARACTERISTICS

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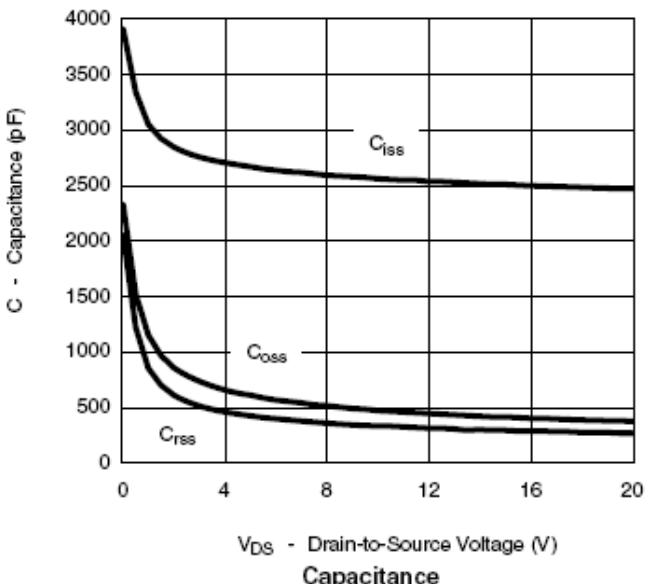
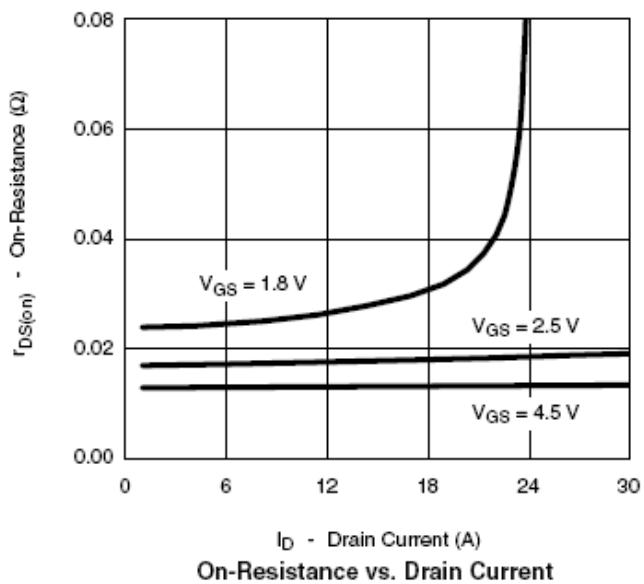
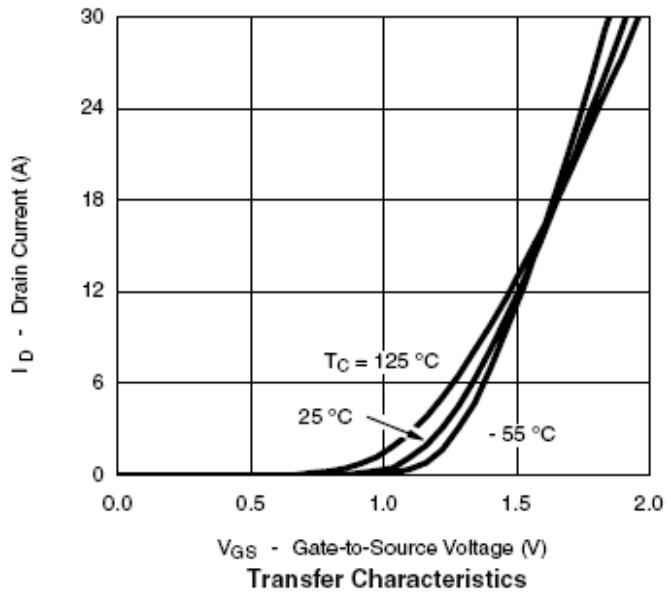
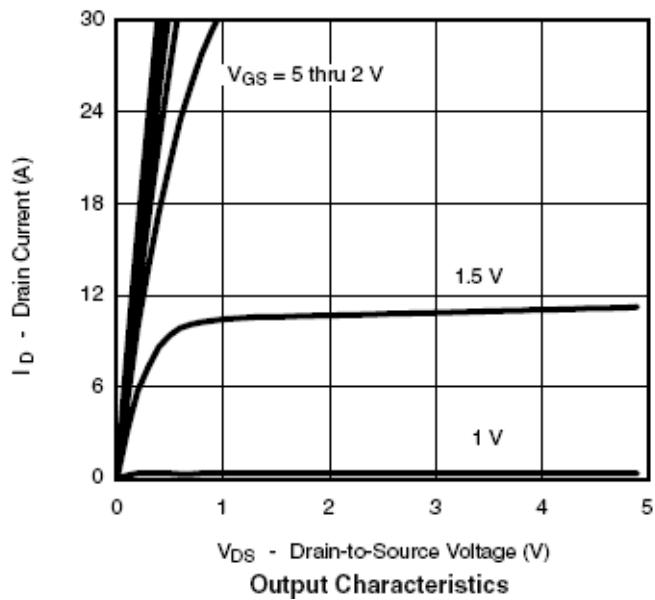
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID=-250μA	-20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>Ds</sub> =V <sub>GS</sub> , ID=-250μA	-0.35		-0.9	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>Ds</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> =-16V, V <sub>GS</sub> =0V			-1	uA
		V <sub>Ds</sub> =-16V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			-10	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>Ds</sub> ≤-5V, V <sub>GS</sub> =-4.5V	-20			A
Drain-Source On-Resistance	R <sub>DSS(on)</sub>	V <sub>GS</sub> =-4.5V, ID=-7.0A		0.018	0.022	Ω
		V <sub>GS</sub> =-2.5V, ID=-6.0A		0.025	0.028	
		V <sub>GS</sub> =-1.8V, ID=-5.0A		0.035	0.040	
Forward Transconductance	g <sub>fs</sub>	V <sub>Ds</sub> =-5.0V, ID=-10.0A		36		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-2.5A, V <sub>GS</sub> =0V		-0.8	-1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>Ds</sub> =-10V, V <sub>GS</sub> =-5.0V ID=-10.0A		30	45	nC
Gate-Source Charge	Q <sub>gs</sub>			4.5		
Gate-Drain Charge	Q <sub>gd</sub>			8.0		
Input Capacitance	C <sub>iss</sub>	V <sub>Ds</sub> =-10V, V <sub>GS</sub> =0V f=1MHz		2670		pF
Output Capacitance	C <sub>oss</sub>			520		
Reverse Transfer Capacitance	C <sub>rss</sub>			480		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-10V, R <sub>L</sub> =15Ω ID=1.0A, V <sub>GEN</sub> =-4.5V R <sub>G</sub> =6Ω		25	40	ns
	t <sub>r</sub>			45	70	
Turn-Off Time	t <sub>d(off)</sub>			145	240	
	t <sub>f</sub>			70	115	



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### TYPICAL CHARACTERISTICS

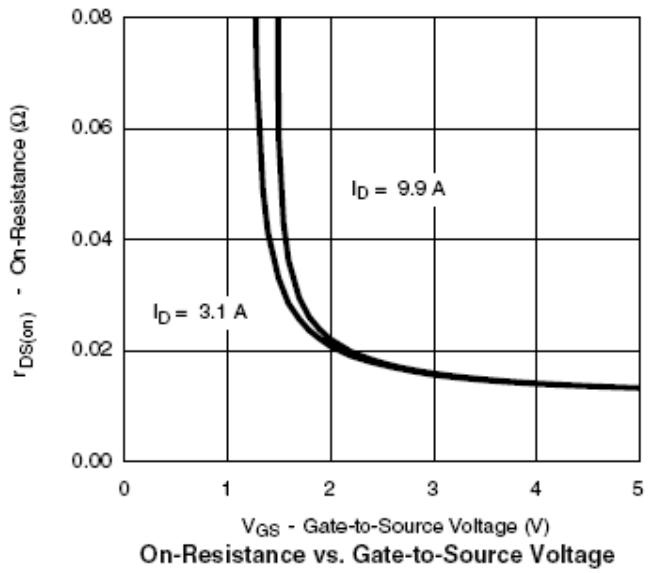
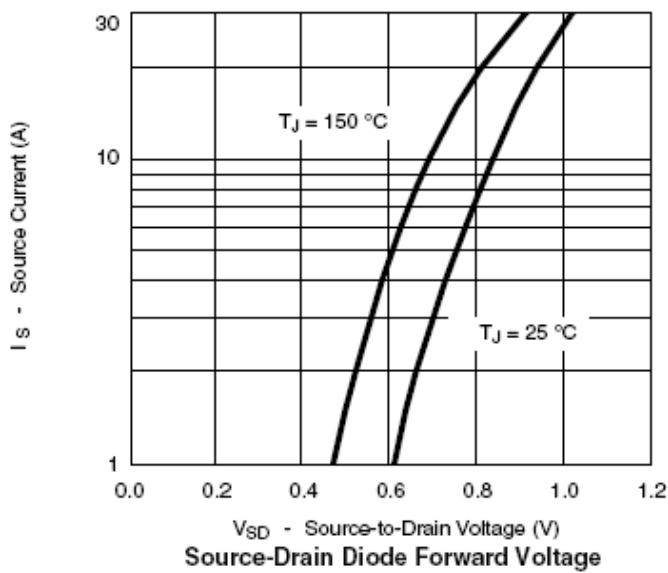
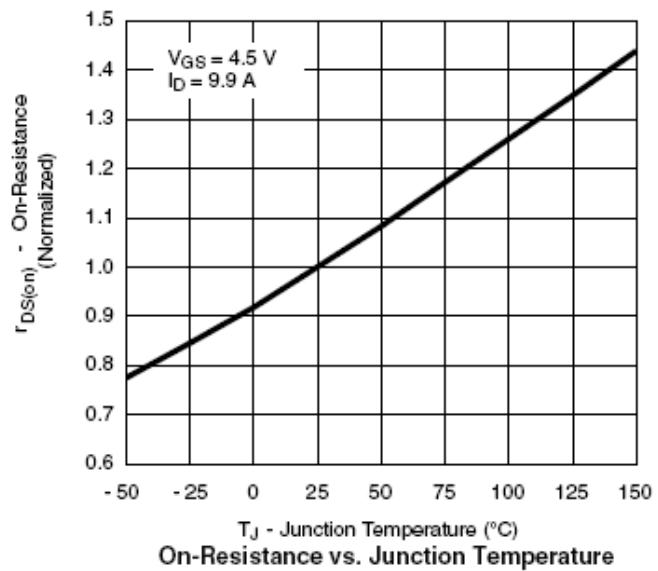
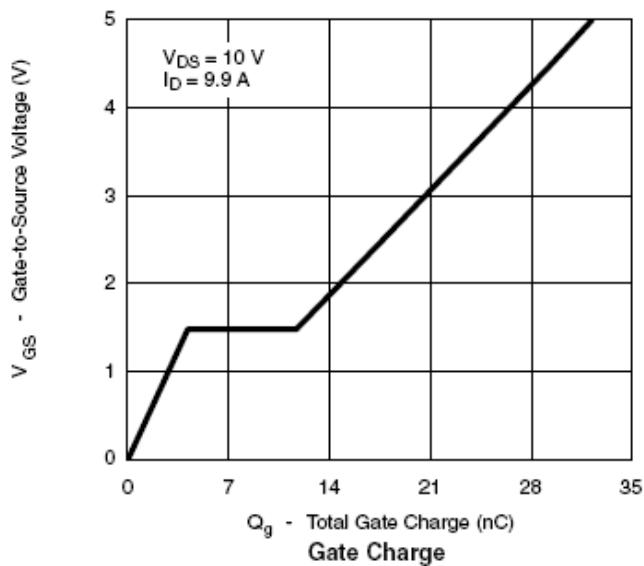




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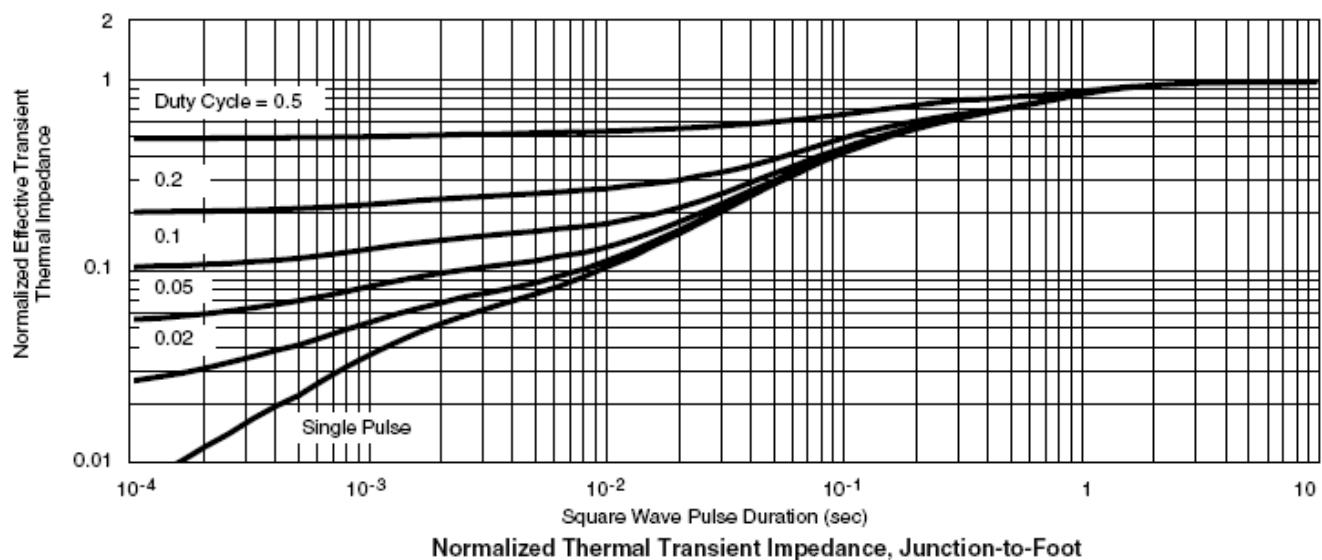
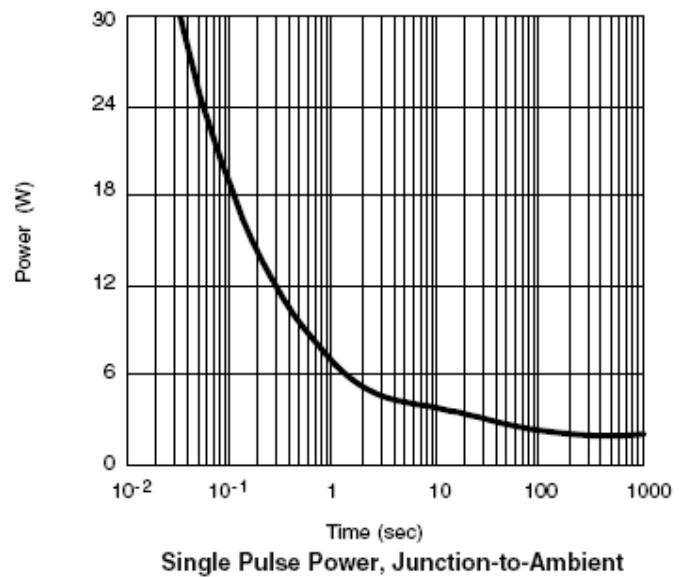
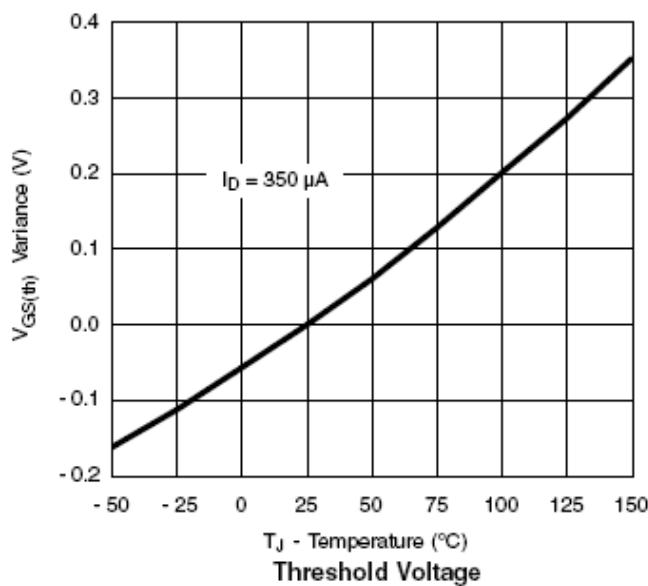




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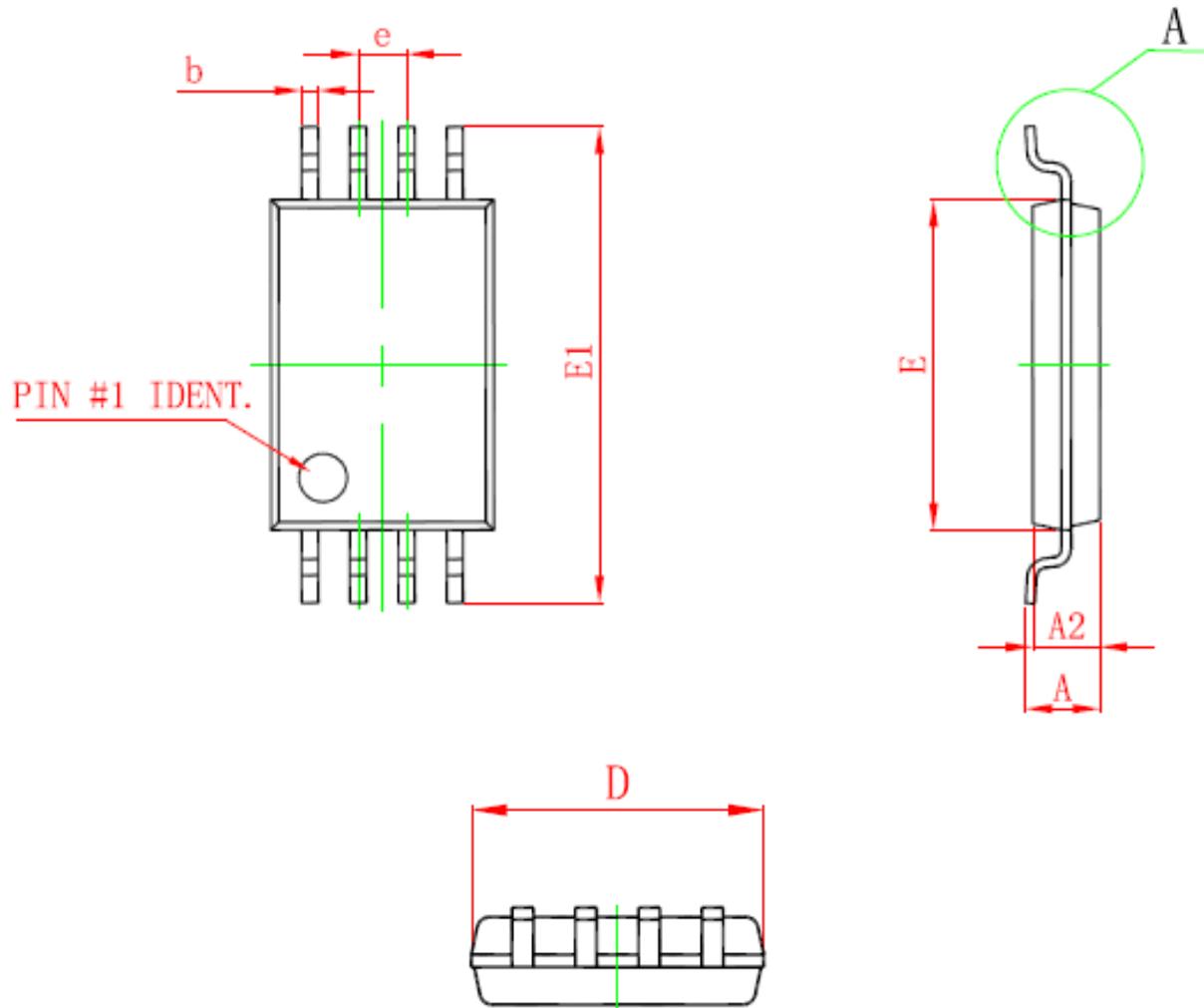




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### TSSOP- 8P PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
A		1.100		0.043
A2	0.800	1.000	0.031	0.039
A1	0.020	0.150	0.001	0.006
e	0.65 (BSC)		0.026 (BSC)	
L	0.500	0.700	0.020	0.028
H	0.25 (TYP)		0.01 (TYP)	
$\theta$	1°	7°	1°	7°



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SYNC Power Corporation  
7F-2, No.3-1, Park Street  
NanKang District (NKSP), Taipei, Taiwan 115  
Phone: 886-2-2655-8178  
Fax: 886-2-2655-8468  
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